

## SEMICONDUCTOR TM

# NDS9956A Dual N-Channel Enhancement Mode Field Effect Transistor

#### **General Description**

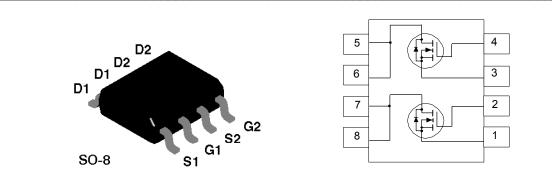
These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulses in the avalanche and commutation modes. These devices are particularly suited for low voltage applications such as DC/DC conversion and DC motor control where fast switching, low in-line power loss, and resistance to transients are needed.

#### Features

- 3.7A, 30V. R<sub>DS(ON)</sub> = 0.08Ω @ V<sub>GS</sub> = 10V
- High density cell design for extremely low R<sub>DS(ON)</sub>.
- High power and current handling capability in a widely used surface mount package.

February 1996

Dual MOSFET in surface mount package.

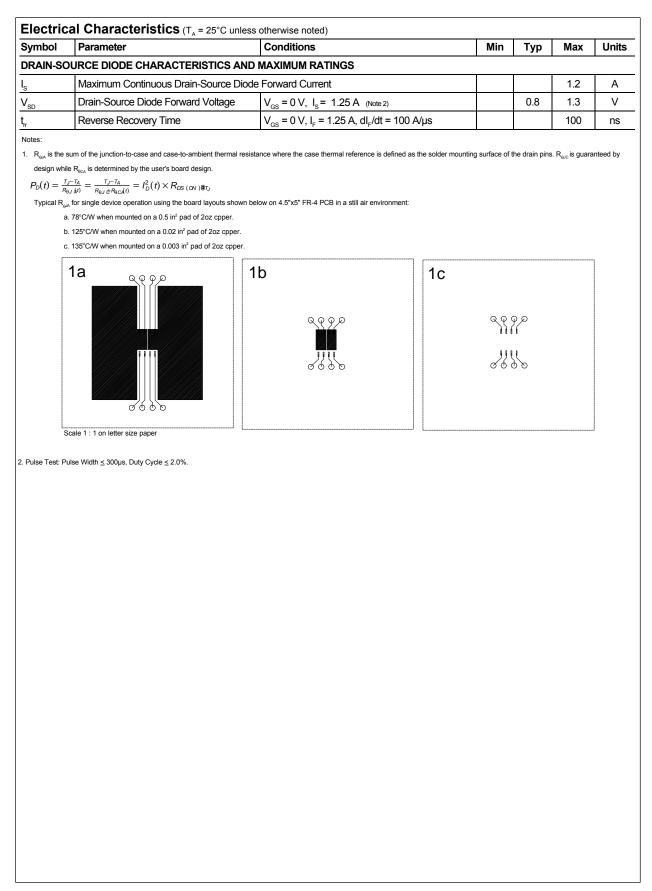


#### Absolute Maximum Ratings T.= 25°C unless otherwise noted

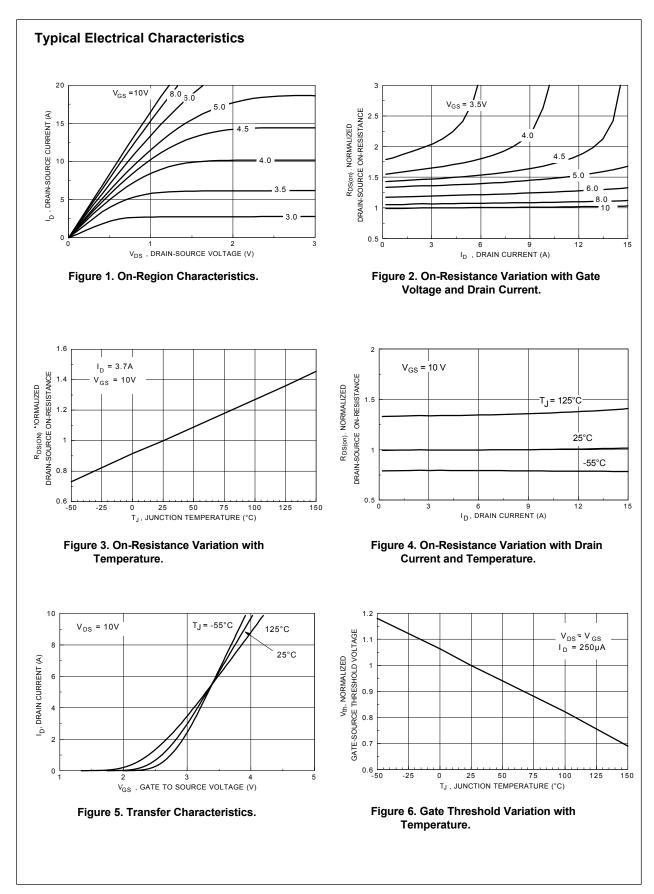
Symbol	Parameter	NDS9956A	Units	
V <sub>DSS</sub>	Drain-Source Voltage	30	V	
V <sub>GSS</sub>	Gate-Source Voltage	± 20	V	
D	Drain Current - Continuous (Note 1a)	± 3.7	A	
	- Pulsed	± 15		
P <sub>D</sub>	Power Dissipation for Dual Operation	2	W	
	Power Dissipation for Single Operation (Note 1a)	1.6		
	(Note 1b)	1		
	(Note 1c)	0.9		
「」,T <sub>stg</sub>	Operating and Storage Temperature Range	-55 to 150	°C	
THERMA	L CHARACTERISTICS			
۲ <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient (Note 1a)	78	°C/W	
ς <sup>θηC</sup>	Thermal Resistance, Junction-to-Case (Note 1)	40	°C/W	

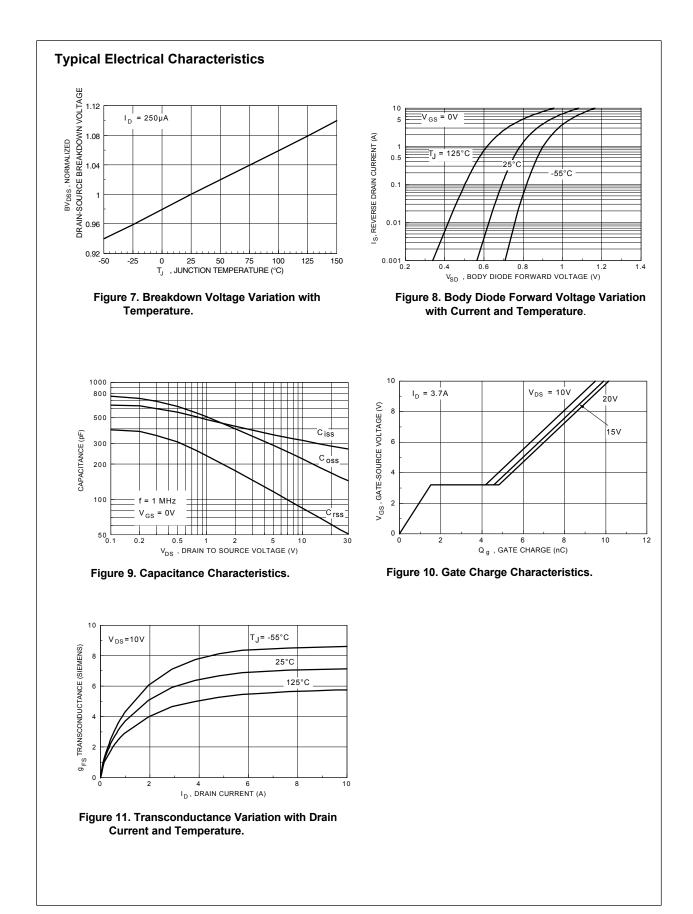
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Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHA	RACTERISTICS						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA		30			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 24 V, V <sub>GS</sub> = 0 V				2	μA
			T_= 55°C			25	μA
GSSF	Gate - Body Leakage, Forward	V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V				100	nA
GSSR	Gate - Body Leakage, Reverse	$V_{GS} = -20 V, V_{DS} = 0 V$				-100	nA
ON CHAR	ACTERISTICS (Note 2)						
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$		1	1.7	2.8	V
			T_= 125°C	0.7	1.2	2.2	1
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 2.2 A			0.06	0.08	Ω
			T <sub>J</sub> = 125°C		0.08	0.13	
		$V_{GS} = 4.5 \text{ V}, I_{D} = 1.0 \text{ A}$	·		0.08	0.11	1
			T_= 125°C		0.11	0.18	1
l <sub>D(on)</sub>	On-State Drain Current	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 10 V		15			Α
		$V_{GS} = 4.5 V, V_{DS} = 10 V$		3.5			1
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 3.7 \text{ A}$			6		S
DYNAMIC	CHARACTERISTICS						
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz			320		pF
C <sub>oss</sub>	Output Capacitance				225		pF
C <sub>rss</sub>	Reverse Transfer Capacitance				85		pF
SWITCHI	IG CHARACTERISTICS (Note 2)						
D(on)	Turn - On Delay Time	$V_{DD} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ A},$ $V_{GEN} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$			10	20	ns
r	Turn - On Rise Time				13	20	ns
D(off)	Tum - Off Delay Time				21	50	ns
f	Turn - Off Fall Time				5	50	ns
J <sup>ª</sup>	Total Gate Charge	$V_{DS} = 10 V,$ $I_{D} = 3.7 A, V_{GS} = 10 V$			9.5	27	nC
$Q_{gs}$	Gate-Source Charge				1.5		nC
Q <sub>gd</sub>	Gate-Drain Charge				3.3		nC

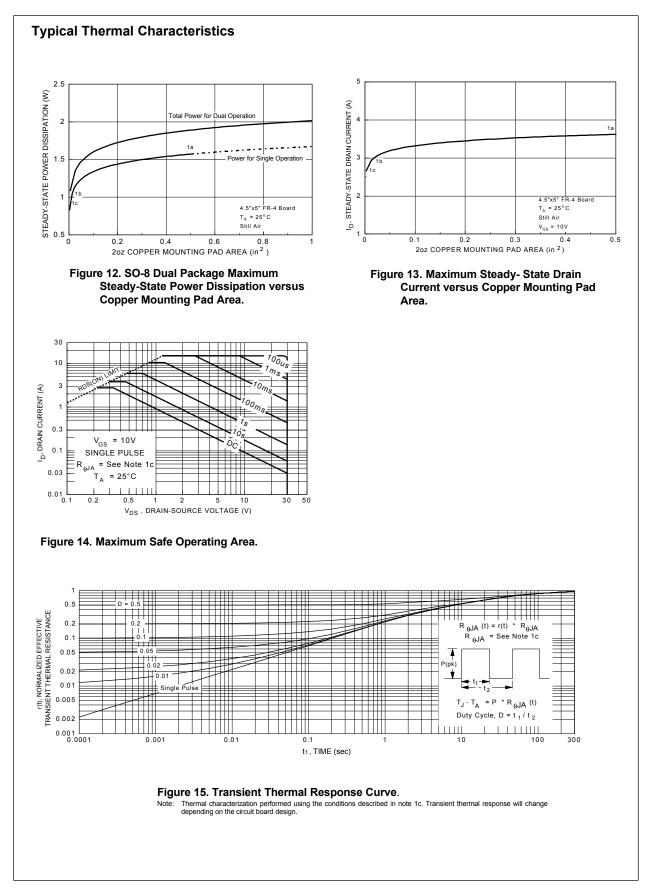


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